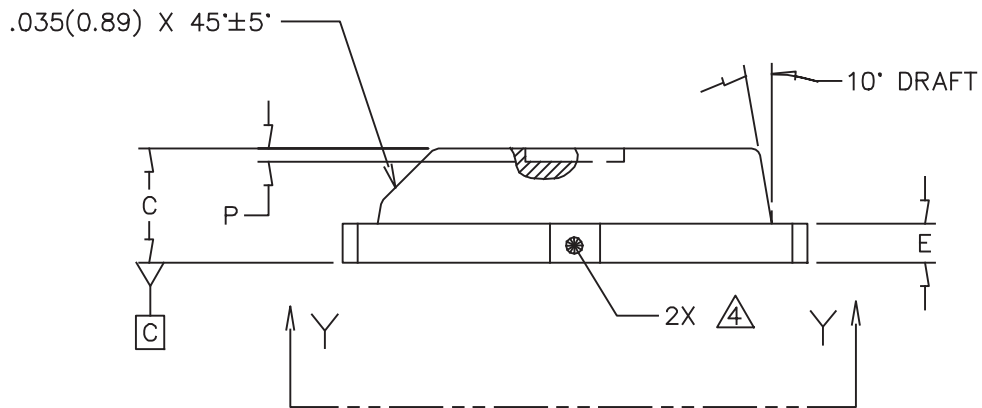
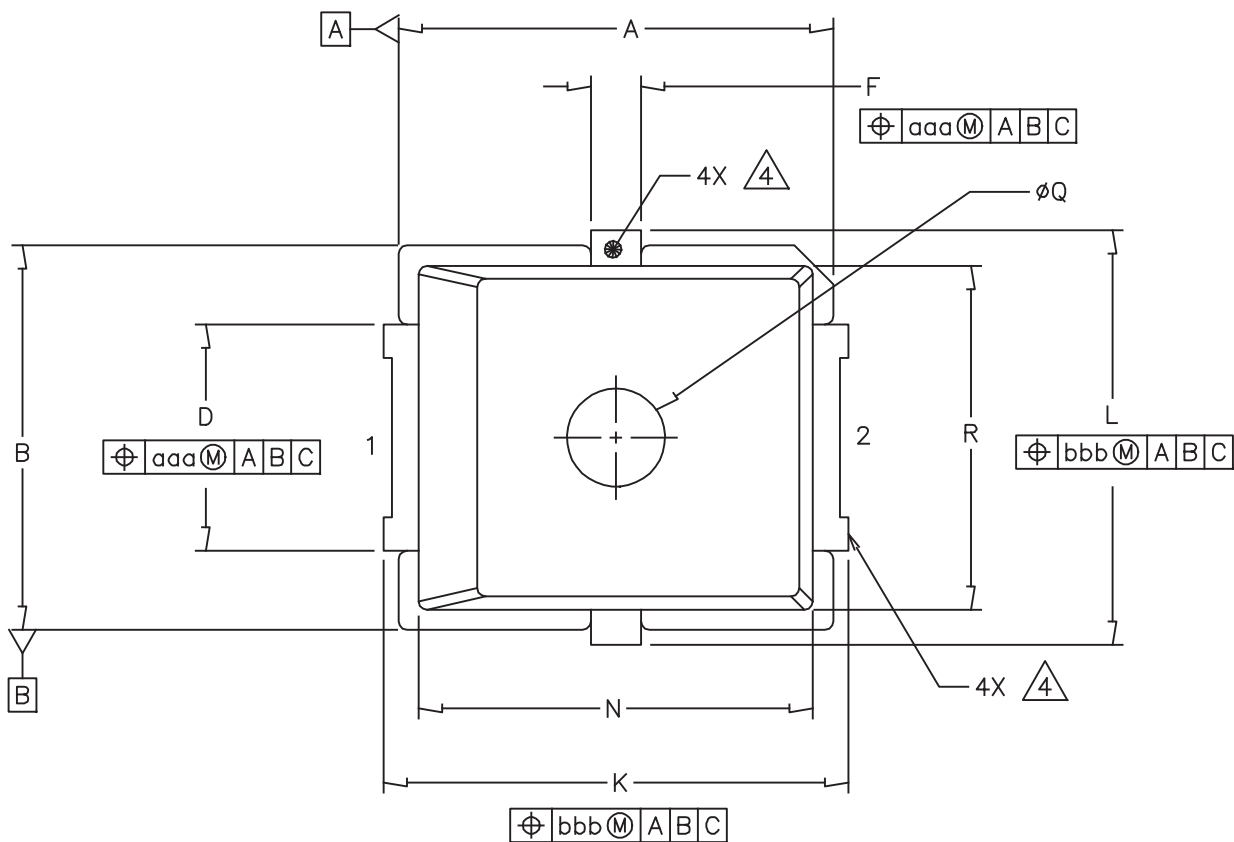
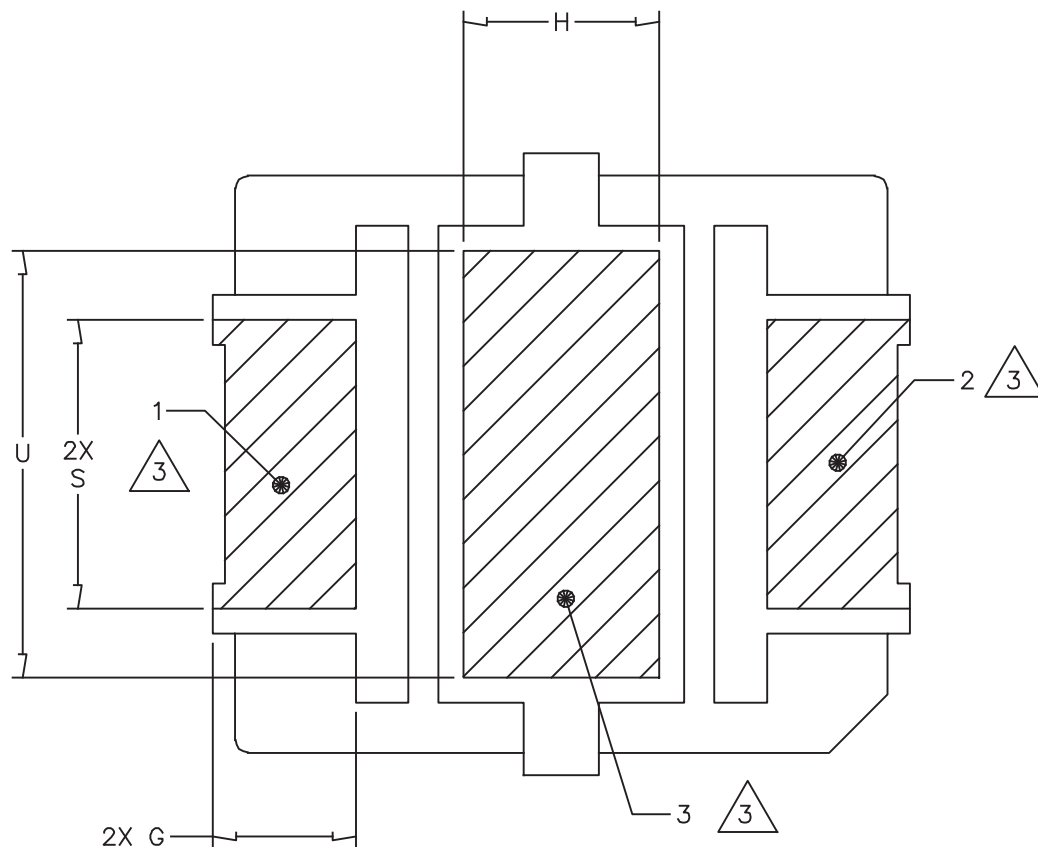


# PACKAGE DIMENSIONS



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TITLE:  PLD-1.5W	DOCUMENT NO: 98ASA00476D	REV: O	
	CASE NUMBER: 2297-01	14 JUN 2012	
	STANDARD: NON-JEDEC		



VIEW Y-Y

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		CASE NUMBER: 2297-01		14 JUN 2012
		STANDARD: NON-JEDEC		

NOTES:

1. CONTROLLING DIMENSION: INCH.

2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.

3. HATCHING REPRESENTS THE EXPOSED AND SOLDERABLE AREA. DIMENSIONS G, S, H AND U REPRESENT THE VALUES BETWEEN THE TWO OPPOSITE POINTS ALONG THE EDGES OF EXPOSED AREA.

4. THESE SURFACES ARE NOT PART OF THE SOLDERABLE SURFACES AND MAY REMAIN UNPLATED.

INCH			MILLIMETER		INCH			MILLIMETER	
DIM	MIN	MAX	MIN	MAX	DIM	MIN	MAX	MIN	MAX
A	.255	.265	6.48	6.73	Q	.055	.063	1.40	1.60
B	.225	.235	5.72	5.97	R	.200	.210	5.08	5.33
C	.065	.072	1.65	1.83	S	.110	—	2.79	—
D	.130	.150	3.30	3.81	U	.156	—	3.96	—
E	.021	.026	0.53	0.66	aaa	.004		0.10	
F	.026	.044	0.66	1.12	bbb	.005		0.13	
G	.038	—	0.97	—					
H	.069	—	1.75	—					
J	.160	.180	4.06	4.57					
K	.273	.285	6.93	7.24					
L	.245	.255	6.22	6.48					
N	.230	.240	5.84	6.10					
P	.000	.008	0.00	0.20					
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